

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4755766

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DEAN GANS	12/12/2017
RECEIVING PARTY DATA	
Name:	MICRON TECHNOLOGY, INC.
Street Address:	8000 SOUTH FEDERAL WAY
City:	BOISE
State/Country:	IDAHO
Postal Code:	83716-9632
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15834892
CORRESPONDENCE DATA	
Fax Number:	(206)299-9288
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2069038800
Email:	ip.dorsey.se@dorsey.com
Correspondent Name:	DORSEY & WHITNEY LLP
Address Line 1:	701 5TH AVENUE, SUITE 6100
Address Line 4:	SEATTLE, WASHINGTON 98104
ATTORNEY DOCKET NUMBER:	P262826US03
NAME OF SUBMITTER:	KIMTON ENG
SIGNATURE:	/Kimton Eng/
DATE SIGNED:	12/29/2017
Total Attachments: 2	
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Dean Gans

For : APPARATUSES AND METHODS
FOR CALIBRATING ADJUSTABLE
IMPEDANCES OF A
SEMICONDUCTOR DEVICE

Docket No. P262826.US.03

Disclosure No. 2015-0665.01/US

ASSIGNMENT:

Enclosed for recording

Previously recorded

Date: _____

Reel: _____

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned does hereby:

SELL, ASSIGN AND TRANSFER to **Micron Technology, Inc.** (the "Assignee"), a corporation of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83716-9632, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the U.S. provisional patent application which was filed December 9, 2016 and assigned Application No. 62/432,494 and is entitled "**APPARATUSES AND METHODS FOR CALIBRATING ADJUSTABLE IMPEDANCES OF A SEMICONDUCTOR DEVICE,**"; such application and all non-provisional, divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and to claim priority based on such application filed in the United States of America;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to

